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<u>MOSFET</u> - Power, Single N-Channel, DFN5/DFNW5 40 V, 4.5 mΩ, 78 A

NVMFS5C460NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C460NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	40	V	
Gate-to-Source Voltage	e		V _{GS}	±20	V	
Continuous Drain	Steady State	$T_{C} = 25^{\circ}C$	۱ _D	78	А	
Current $R_{\theta JC}$ (Notes 1, 3)		T _C = 100°C		55		
Power Dissipation		$T_C = 25^{\circ}C$	PD	50	W	
R _{θJC} (Note 1)		$T_{C} = 100^{\circ}C$		25		
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	۱ _D	21	А	
Current R _{θJA} (Notes 1, 2, 3)		T _A = 100°C		15		
Power Dissipation		$T_A = 25^{\circ}C$	PD	3.6	W	
$R_{\theta JA}$ (Notes 1, 2)		$T_A = 100^{\circ}C$		1.8		
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	396	А	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +175	°C		
Source Current (Body Diode)		I _S	56	А		
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 5 A$)		E _{AS}	107	mJ		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C		

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

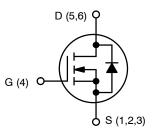
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	3.0	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	42	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	4.5 m Ω @ 10 V	78 A
40 V	7.2 mΩ @ 4.5 V	,07



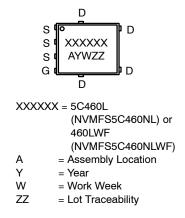
N-CHANNEL MOSFET



DFN5 (SO-8FL) CASE 488AA

DFNW5 (FULL-CUT SO8FL WF) CASE 507BA

MARKING DIAGRAM



ORDERING INFORMATION

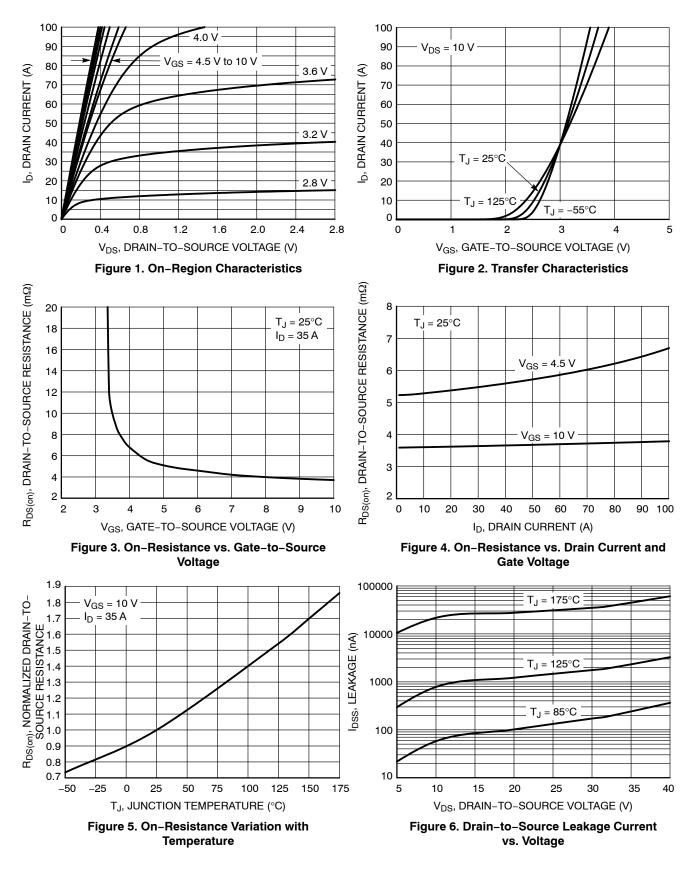
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

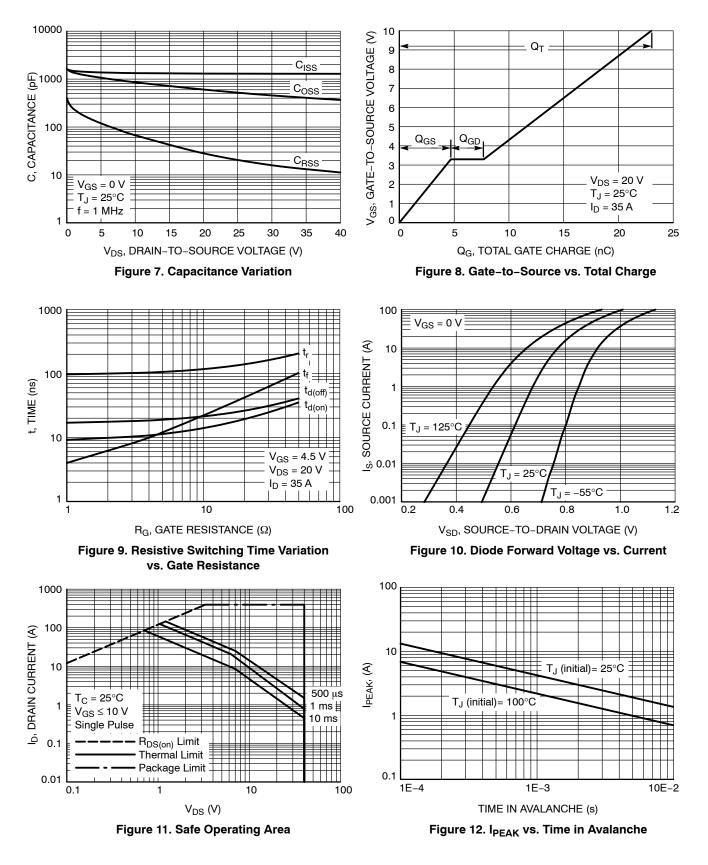
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				21		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25 °C			10	μΑ
		V _{DS} = 40 V	T _J = 125°C			250	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = 20 V$				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 40 \ \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.1		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 35 A		5.8	7.2	mΩ
		V _{GS} = 10 V	I _D = 35 A		3.7	4.5	
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D = 35 A			72		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			1300		pF
Output Capacitance	C _{OSS}				530		
Reverse Transfer Capacitance	C _{RSS}				25		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 20 V; I_{D} = 35 A			23		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 20 V; I _D = 35 A			11		nC V
Threshold Gate Charge	Q _{G(TH)}				2.5		
Gate-to-Source Charge	Q _{GS}				4.7		
Gate-to-Drain Charge	Q _{GD}				3.0		
Plateau Voltage	V _{GP}				3.3		
SWITCHING CHARACTERISTICS (Note 5	5)					-	-
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 20 V, I_{D} = 35 A, R_{G} = 1 Ω			9.2		- ns
Rise Time	tr				3.4		
Turn-Off Delay Time	t _{d(OFF)}				17		
Fall Time	t _f				4.4		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V_{c}$	$T_J = 25^{\circ}C$		0.86	1.2	
	$I_{\rm S} = 35 \rm{A}$	V _{GS} = 0 V, I _S = 35 A	T _J = 125°C		0.75		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dls/dt = 100 A/µs, I _S = 35 A			29		ns
Charge Time	t _a				14		
Discharge Time	t _b				14		
Reverse Recovery Charge	Q _{RR}				12		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Pulse Test: pulse width ≤ 300 µs, duty cycle ≤ 2%.
5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

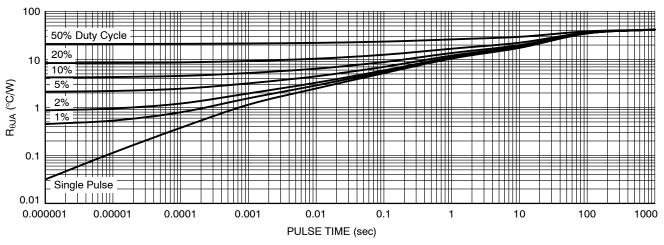


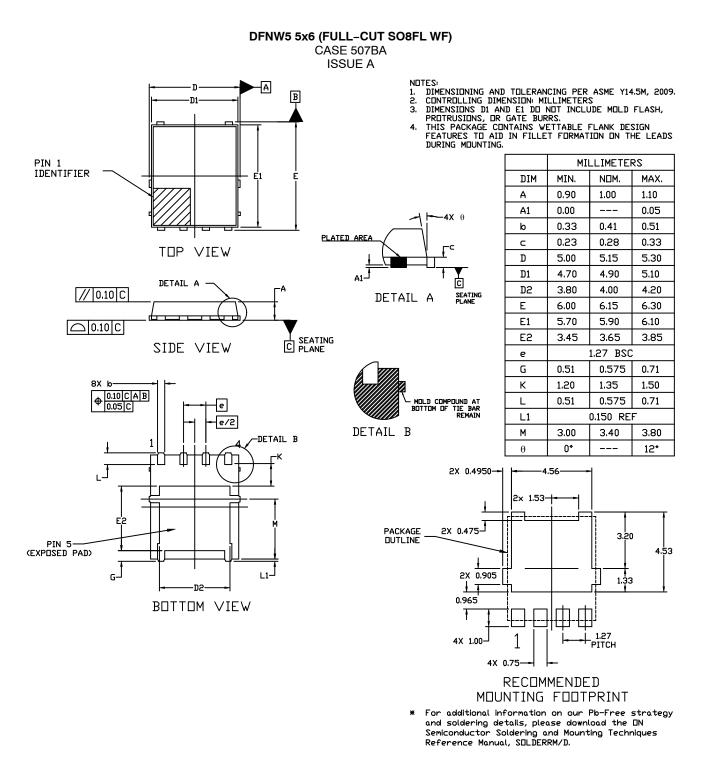
Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†] 1500 / Tape & Reel	
NVMFS5C460NLT1G	5C460L	DFN5 (Pb-Free)		
NVMFS5C460NLWFT1G	460LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C460NLT3G	5C460L	DFN5 (Pb-Free)	5000 / Tape & Reel	
NVMFS5C460NLWFT3G	460LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel	
NVMFS5C460NLAFT1G	5C460L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C460NLAFT1G-YE	5C460L	DFN5 (Pb-Free)	1500 / Tape & Reel	
NVMFS5C460NLWFAFT1G	460LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel	
NVMFS5C460NLWFAFT3G	460LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel	

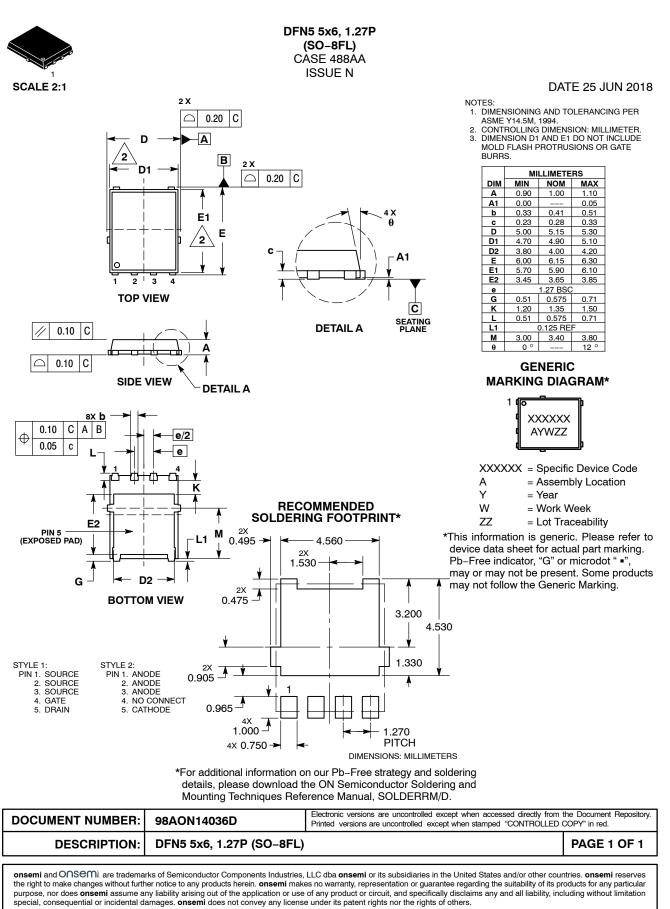
DEVICE ORDERING INFORMATION

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



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